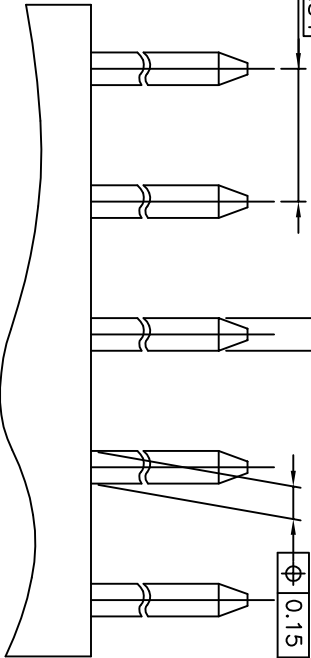
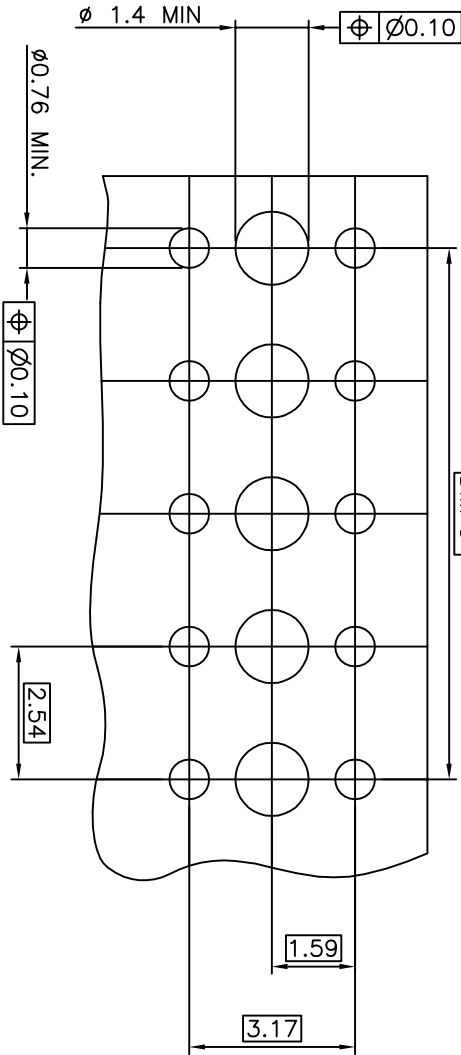
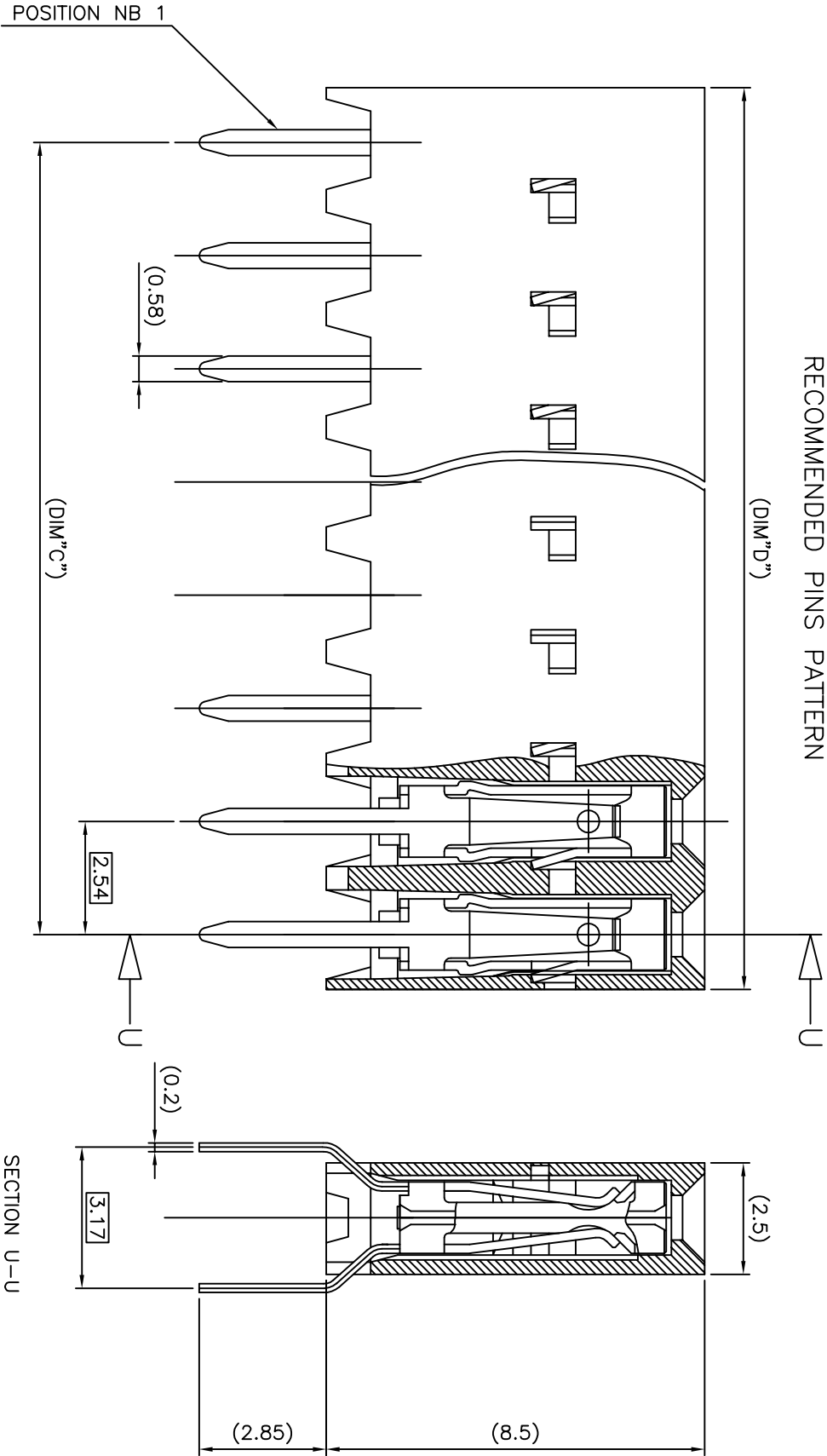


PRODUCT N°	DIM"C"	DIM"D"	CONTACT PLACED IN CAVITY																									
95200-Y01LF	48.26	50.72	X	X	X				X	X	X	X	X	X							X	X						
95200-Y02LF	7.62	10.08	X		X																							
95200-Y03LF	53.34	55.80	X			X							X								X							X
95200-Y04LF	53.34	55.80	X	X		X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X

ROHS COMPATIBLE,
SEE NOTE 3



MINIMUM MATING PIN LENGTH: 5 mm.
RECOMMENDED PINS PATTERN



RECOMMENDED HOLE PATTERN.

NOTES:

- 1 - MATERIAL HOUSING: THERMOPLASTIC POLYESTER, 30% GLASS FILLED, COLOUR BLUE, FLAME RETARDANT: PER UL-94 CATEGORY VO.
MATERIAL TERMINAL: PHOSPHORE BRONZE EXTRA HARD.
- 2 - CONNECTOR MEANT TO BE USED FOR PC BOARD WITH NON PLATED THROUGH HOLES.
- 3 - ROHS COMPATIBLE PRODUCT SPECIFICATIONS
- d - PLATING:
 - "LF" MEANS THE PRODUCT IS LEAD-FREE, 2µm MINIMUM MATTE TIN OVER 1.27µm MINIMUM NICKEL UNDERPLATE.
- b - MANUFACTURING PROCESS COMPATIBILITY
 - THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C ±5°C SOLDER BATH TEMPERATURE FOR 5 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.6mm MIN THICK CIRCUIT BOARD.
- c - LABELING:
 - MEETS PACKAGING SPECS AS PER GS-14-920
- d - LEGAL STATEMENT: SEE GS-47-0004

95200-4XXLF	5 µm Sn	Sn
95200-3XXLF	0.76 µm GOLD	Sn
PLATING CODE	CONTACT AREA	SOLDER TAIL
	PLATING THICKNESS OVER 1.27µm Ni	

mat'l. code	surface	tolerance	projection	product family
SEE NOTES	ISO 1302	ISO 406 ISO 1111	Ø	DX VCC SR
litr ecn no dr date	tolerances unless otherwise specified	0±.x	mm	title
H F04-0347DIE 04.11.15	angles	0±.x	mm	OFF SET LEGS
J F06-0233DIE 06.07.13	linear	.000±.00x	mm	SELECTED LOADED
K F07-0271LMU 07.12.06	0°±x°		scale 10:1	
L B-19123 LMU 14.10.21	DIEGRAND	01.12.05		
M B-19232 LMU 14.10.28	PINZZI	01.12.05		
G F03-0284DIE 03.10.15	DIEGRAND	01.12.05		
sheet revision	index	sheet		